

RoHS Compliant Product
A suffix of "-C" specifies halogen free

DESCRIPTION

The SSD70N08S-C is the highest performance N-Ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The SSD70N08S-C meet the RoHS and Green Product requirement with full function reliability approved.

FEATURES

- High Speed Power Switching
- Super Low Gate Charge
- Green Device Available

MARKING



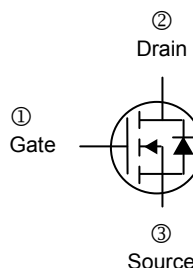
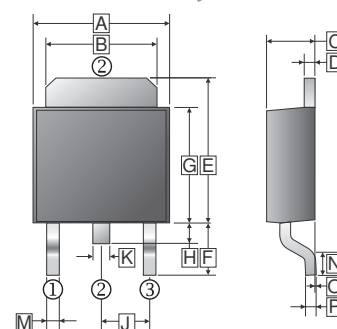
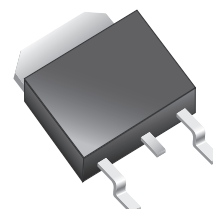
PACKAGE INFORMATION

Package	MPQ	Leader Size
TO-252	2.5K	13 inch

ORDER INFORMATION

Part Number	Type
SSD70N08S-C	Lead (Pb)-free and Halogen-free

TO-252(D-Pack)



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	6.3	6.9	J	2.3	REF.
B	4.95	5.53	K	0.89	REF.
C	2.1	2.5	M	0.45	1.14
D	0.4	0.9	N	1.55	Typ.
E	6	7.7	O	0	0.15
F	2.90	REF.	P	0.58	REF.
G	5.4	6.4			
H	0.6	1.2			

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹ , @ $V_{GS}=10V$	I_D	$T_C=25^\circ C$	70
		$T_C=100^\circ C$	44
Pulsed Drain Current ²	I_{DM}	160	A
Total Power Dissipation ³	P_D	52	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~150	$^\circ C$
Thermal Resistance Ratings			
Maximum Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	62	$^\circ C/W$
Maximum Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	2.4	

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Drain-Source Breakdown Voltage	BV_{DSS}	80	-	-	V	$V_{GS}=0, I_D=250\mu\text{A}$	
Gate Threshold Voltage	$V_{GS(th)}$	1	-	2.5	V	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	
Forward Transconductance	g_{fs}	-	75	-	S	$V_{DS}=5\text{V}, I_D=20\text{A}$	
Gate-Source Leakage Current	I_{GSS}	-	-	± 100	nA	$V_{GS}=\pm 20\text{V}$	
Drain-Source Leakage Current	I_{DSS}	$T_J=25^\circ\text{C}$	-	-	1	μA	$V_{DS}=64\text{V}, V_{GS}=0$
		$T_J=55^\circ\text{C}$	-	-	5		$V_{DS}=64\text{V}, V_{GS}=0$
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	-	4.6	6.9	m Ω	$V_{GS}=10\text{V}, I_D=15\text{A}$	
		-	6.8	8.8		$V_{GS}=4.5\text{V}, I_D=15\text{A}$	
Total Gate Charge	Q_g	-	40	-	nC	$I_D=15\text{A}$ $V_{DS}=40\text{V}$ $V_{GS}=10\text{V}$	
Gate-Source Charge	Q_{gs}	-	7.2	-			
Gate-Drain Change	Q_{gd}	-	6.5	-			
Turn-on Delay Time	$T_{d(on)}$	-	8.3	-	nS	$V_{DD}=40\text{V}$ $I_D=15\text{A}$ $V_{GS}=10\text{V}$ $R_G=3\Omega$	
Rise Time	T_r	-	4.2	-			
Turn-off Delay Time	$T_{d(off)}$	-	36	-			
Fall Time	T_f	-	6.9	-			
Input Capacitance	C_{iss}	-	2860	-	pF	$V_{GS}=0$ $V_{DS}=40\text{V}$ $f=1\text{MHz}$	
Output Capacitance	C_{oss}	-	410	-			
Reverse Transfer Capacitance	C_{rss}	-	38	-			
Source-Drain Diode							
Diode Forward Voltage ²	V_{SD}	-	-	1.2	V	$V_{GS}=0, I_S=1\text{A}, T_J=25^\circ\text{C}$	
Continuous Source Current ¹	I_S	-	-	70	A		
Reverse Recovery Time	t_{rr}	-	27	-	nS	$I_F=20\text{A}, dI/dt=100\text{A}/\mu\text{s},$ $T_J=25^\circ\text{C}$	
Reverse Recovery Charge	Q_{rr}	-	89	-	nC		

Notes:

- Surface Mounted on 1inch² FR4 Board with 2OZ copper.
- The data tested by pulsed, Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- The power dissipation is limited by 150°C, junction temperature.

TYPICAL CHARACTERISTICS CURVE

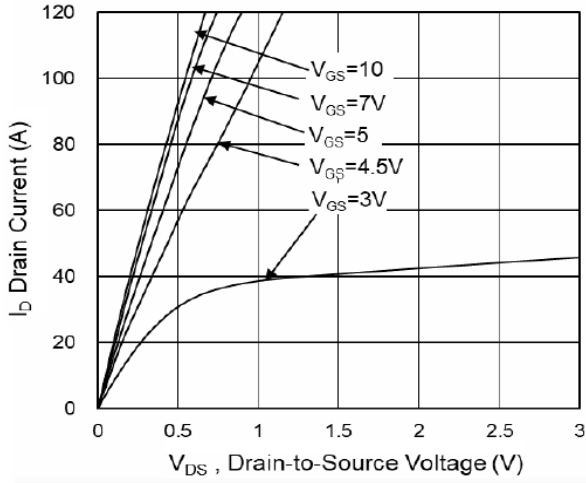


Fig.1 Typical Output Characteristics

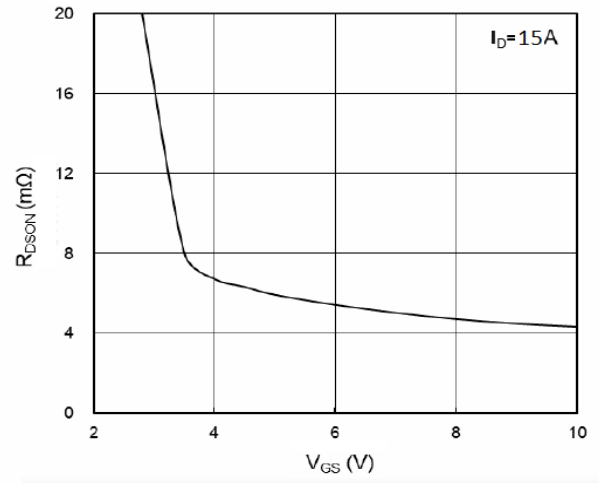


Fig.2 On-Resistance vs G-S Voltage

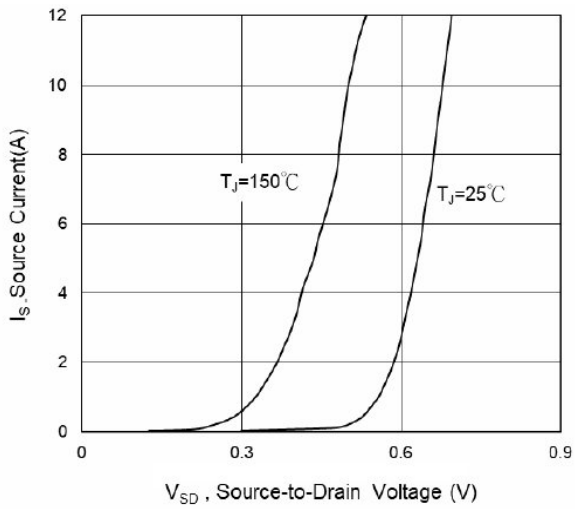


Fig.3 Source Drain Forward Characteristics

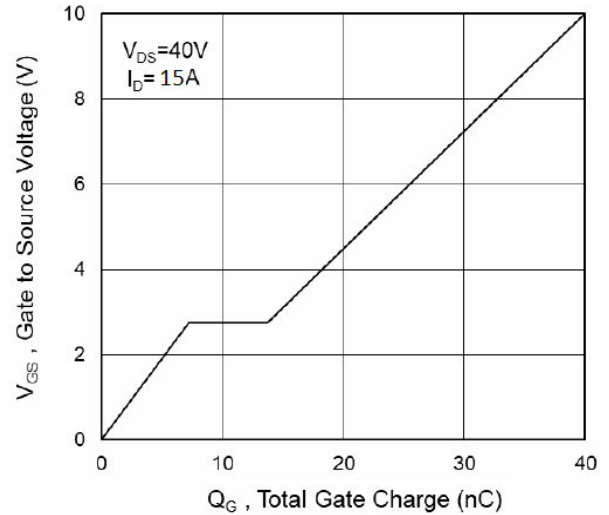


Fig.4 Gate-Charge Characteristics

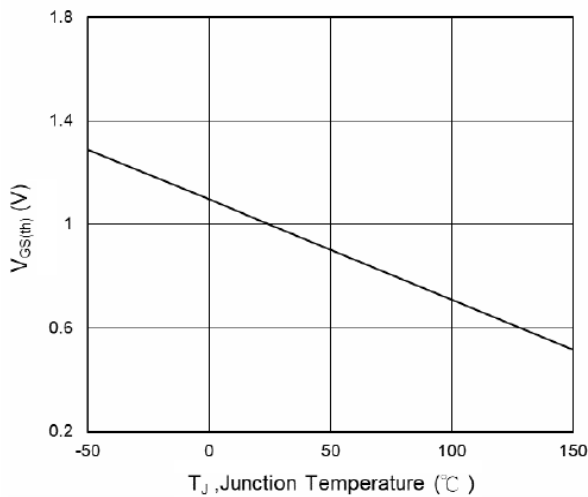


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

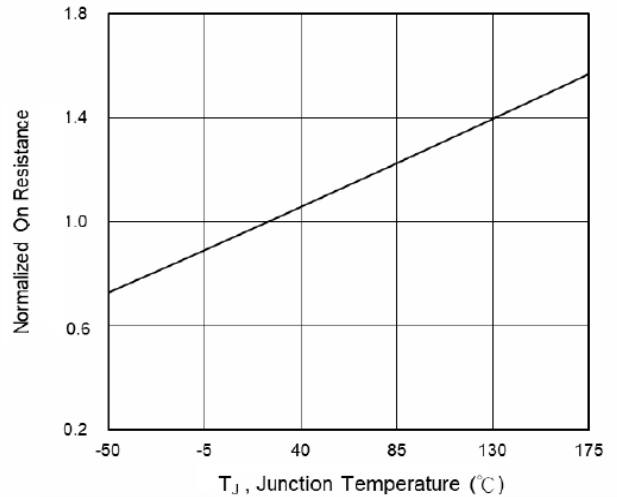


Fig.6 Normalized $R_{DS(ON)}$ vs. T_J

TYPICAL CHARACTERISTICS CURVE

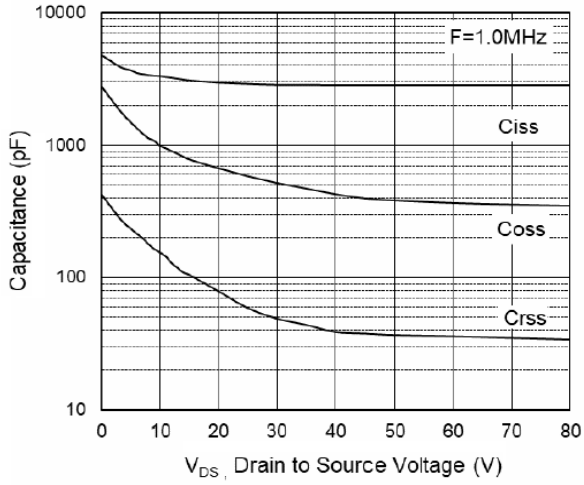


Fig.7 Capacitance

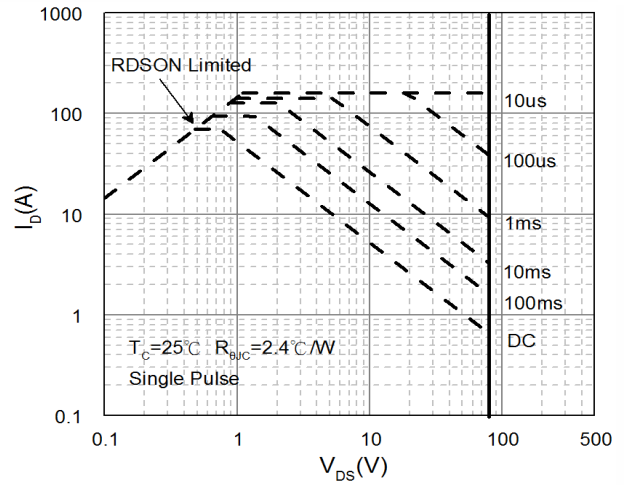


Fig.8 Safe Operating Area

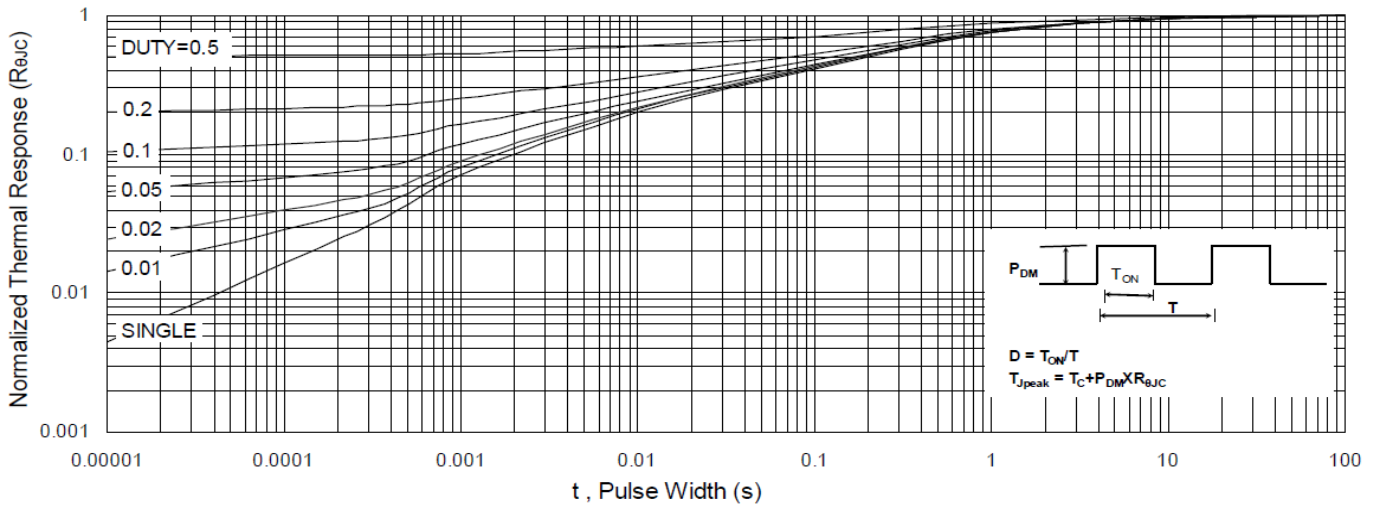


Fig.9 Normalized Maximum Transient Thermal Impedance

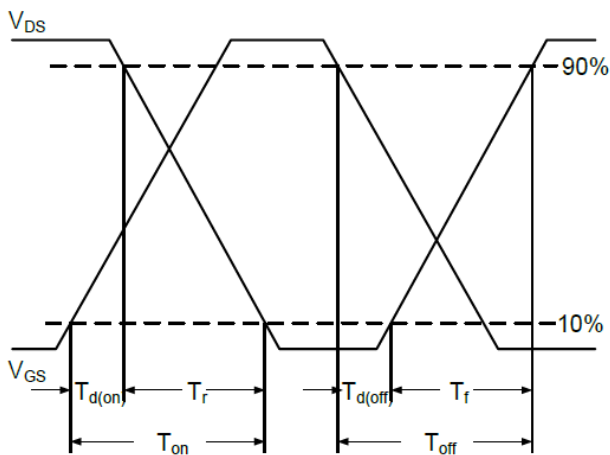


Fig.10 Switching Time Waveform

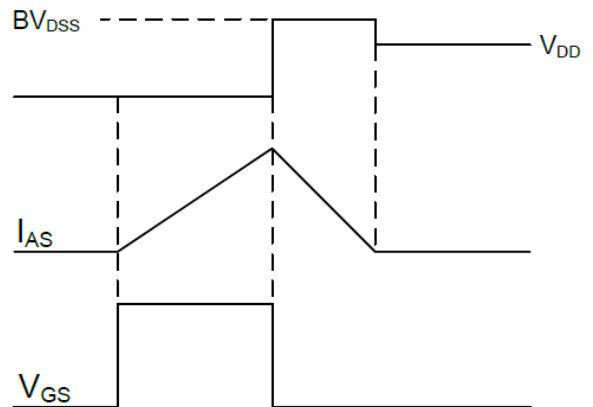


Fig.11 Unclamped Inductive Waveform